

ABSTRACT

A computer cooling system devised with a computer housing, which is a sealed body and has a plurality of paths. An end portion of the sealed body is connected to a heat conducting plate via pipes thereof. The
5 heat conducting plate is directly attached to a CPU, hard disc or other computer components that need heat dissipation. The paths of the housing are filled with a cooling liquid that is circulated between an interior of the housing and the heat conducting plate using a pump, thereby rapidly lowering temperatures of the computer components to
10 which the heat conducting plate is attached. The housing is made of a material such as aluminum having a good thermal conductance coefficient. In conjunction with circulation of the cooling liquid, temperatures in the computer are rapidly exchanged by the housing and thus controlled within a recommended operating temperature range.